



## Material Content Data Sheet



<b>Sales Product Name</b>				SAK-TC1784F-320F180EP BA		<b>Issued</b>		20. July 2018	
<b>MA#</b>				MA001507156					
<b>Package</b>				PG-LFBGA-292-6		<b>Weight*</b>		934.82 mg	
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip	inorganic material	silicon	7440-21-3	20.624	2.21	2.21	22062	22062	
wire	noble metal	palladium	7440-05-3	0.014	0.00		15		
	non noble metal	copper	7440-50-8	1.396	0.15	0.15	1493	1508	
encapsulation	organic material	carbon black	1333-86-4	0.711	0.08		761		
	plastics	epoxy resin	-	49.060	5.25		52480		
	inorganic material	silicondioxide	60676-86-0	305.734	32.71	38.04	327049	380290	
substrate	plastics	epoxy resin	-	6.479	0.69		6931		
	inorganic material	bariumsulfate	7727-43-7	9.942	1.06		10635		
	plastics	acrylic resin	-	11.506	1.23		12308		
	inorganic material	aluminiumhydroxide	21645-51-2	53.265	5.70		56979		
	plastics	epoxy bismaleimide triazine resin	-	61.156	6.54		65420		
	inorganic material	glass fibre	-	82.857	8.86		88634		
	non noble metal	copper	7440-50-8	196.577	21.03	45.11	210283	451190	
plating	noble metal	gold	7440-57-5	1.231	0.13		1317		
	non noble metal	nickel	7440-02-0	3.370	0.36	0.49	3605	4922	
solderball	noble metal	silver	7440-22-4	4.457	0.48		4768		
	non noble metal	tin	7440-31-5	122.898	13.15	13.63	131467	136235	
glue	plastics	epoxy resin	-	0.887	0.09		948		
	noble metal	silver	7440-22-4	2.660	0.28	0.37	2845	3793	
*deviation	< 10%			Sum in total:		100.00		1000000	

### Important Remarks:

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